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SS52 THRU SS5200

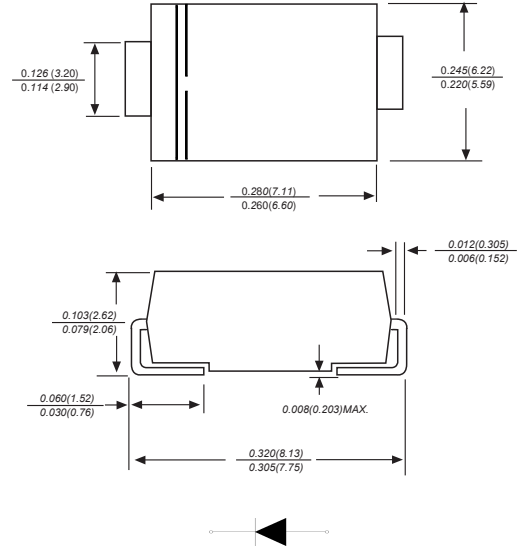
Reverse Voltage - 20 to 200 Volts Forward Current - 5.0 Ampere

SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Metal silicon junction, majority carrier conduction
- ◆ Low power loss, high efficiency
- ◆ Built-in strain relief, ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:
250 °C/10 seconds at terminals

DO-214AB/SMC **RoHS COMPLIANT**



Dimensions in inches and (millimeters)

Mechanical Data

Case JEDEC DO-214AB/SMC molded plastic body
 Terminals Solderable per MIL-STD-750, Method 2026
 Polarity Color band denotes cathode end
 Mounting Position Any
 Weight : 0.007ounce, 0.25 grams

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	SS52	SS53	SS54	SS55	SS56	SS58	SS510	SS5150	SS5200	UNITS	
		MDD SS52	MDD SS53	MDD SS54	MDD SS55	MDD SS56	MDD SS58	MDD SS510	MDD SS5150	MDD SS5200		
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	40	50	60	80	100	150	200	V	
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	56	70	105	140	V	
Maximum DC blocking voltage	V _{DC}	20	30	40	50	60	80	100	150	200	V	
Maximum average forward rectified current at TL (see fig.1)	I _(AV)	5.0									A	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	150									A	
Maximum instantaneous forward voltage at 5.0A	V _F	0.55		0.70		0.85		0.95			V	
Maximum DC reverse current at rated DC blocking voltage T _A =25°C T _A =125°C	I _R	0.5						0.2			mA	
Typical junction capacitance (NOTE 1)	C _J	20						10		2.0		pF
Typical thermal resistance (NOTE 2)	R _{θJA}	50.0									°C/W	
Operating junction temperature range	T _J	-50 to +125					-50 to +150					°C
Storage temperature range	T _{STG}	-50 to +150									°C	

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
 2. P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas



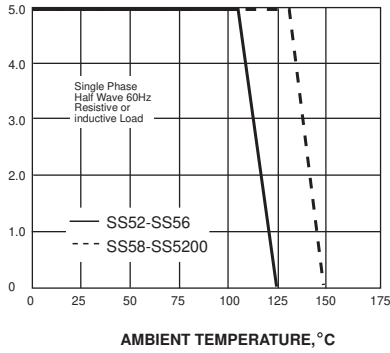
SS52 THRU SS5200

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Typical Characteristics

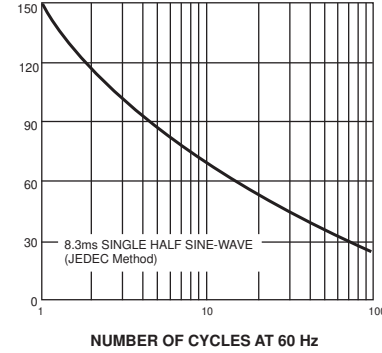
AVERAGE FORWARD RECTIFIED CURRENT, AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



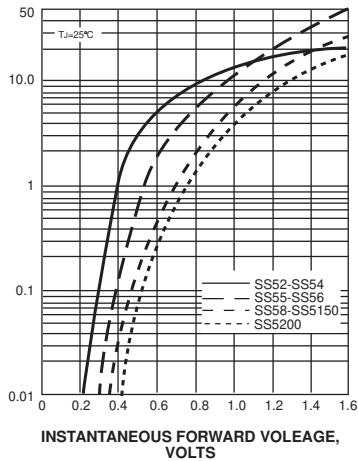
PEAK FORWARD SURGE CURRENT, AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



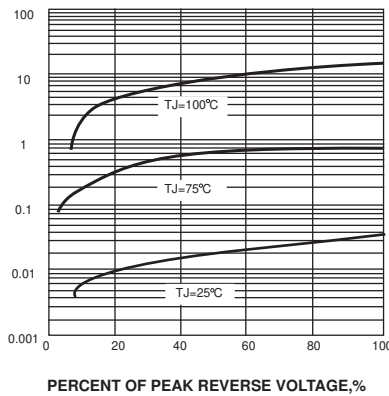
INSTANTANEOUS FORWARD CURRENT, AMPERES

FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



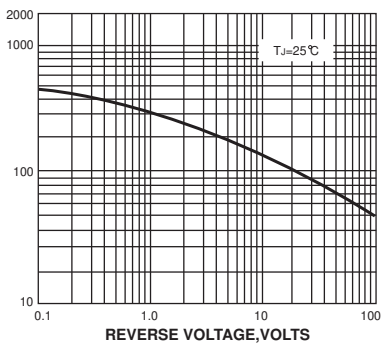
INSTANTANEOUS REVERSE CURRENT, MILLIAMPERES

FIG. 4-TYPICAL REVERSE CHARACTERISTICS



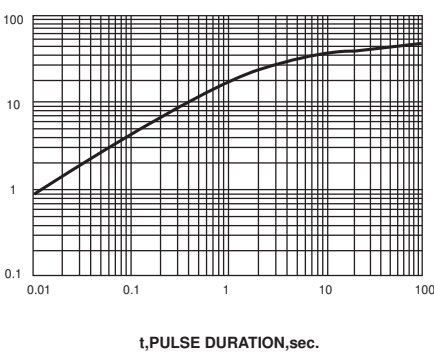
JUNCTION CAPACITANCE, pF

FIG. 5-TYPICAL JUNCTION CAPACITANCE



TRANSIENT THERMAL IMPEDANCE, °C/W

FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE



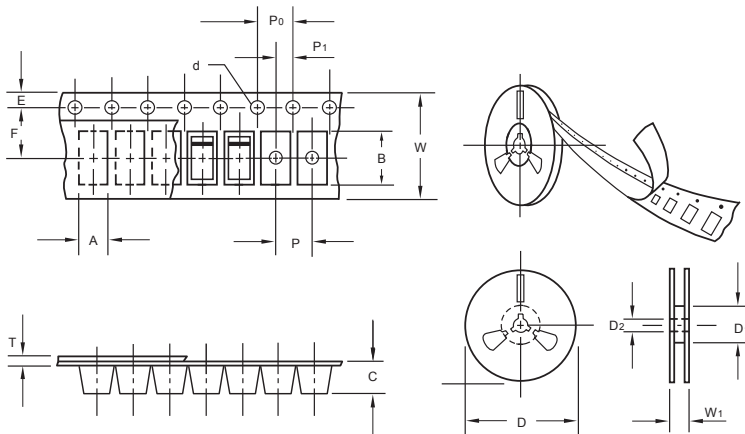
The curve above is for reference only.



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Packing information



unit:mm

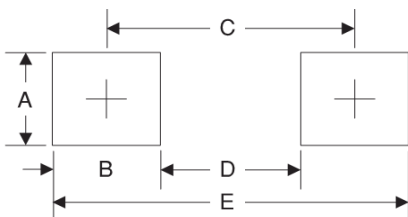
Item	Symbol	Tolerance	SMC
Carrier width	A	0.1	6.15
Carrier length	B	0.1	8.41
Carrier depth	C	0.1	2.42
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D ₁	min	50.00
Feed hole diameter	D ₂	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	7.50
Punch hole pitch	P	0.1	8.00
Sprocket hole pitch	P ₀	0.1	4.00
Embossment center	P ₁	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	16.00
Reel width	W ₁	1.0	16.50

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (mm)	BOX (pcs)	INNER BOX (mm)	REEL DIA. (mm)	CARTON SIZE (mm)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMC	13"	3,000	4.0	6000	190*190*41	330	365*365*340	42000	14.0

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	4.3	0.170
B	4.1	0.160
C	7.9	0.311
D	3.8	0.150
E	12	0.472

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